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Technical Data Sheet

Reverse Package Chip LED

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

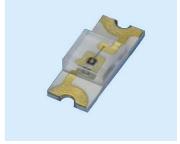
- The 23-21B SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

D. (N	Chip		Resin Color	
Part No.	Material	Emitted Color		
23-21B/Y2C-AQ1R2/2A	AlGaInP	Brilliant Yellow	Water Clear	



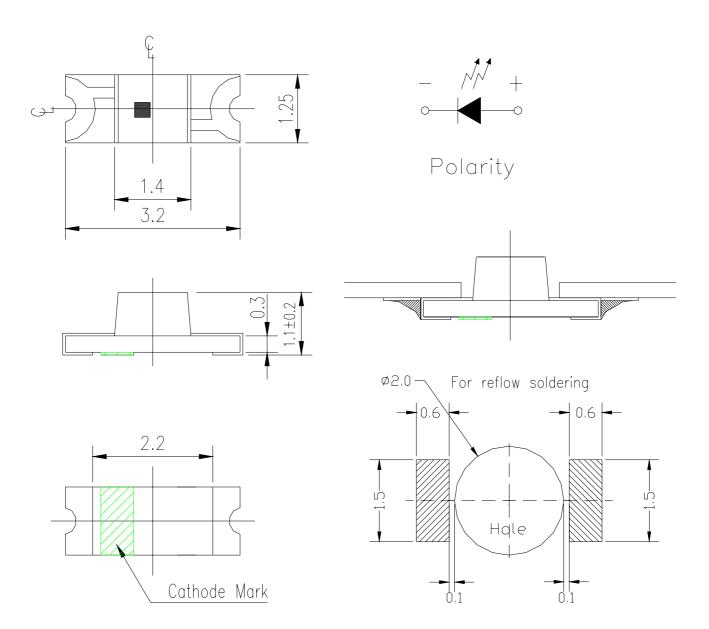
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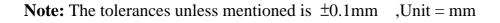
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Package Outline Dimensions





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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260° C for 10sec. Hand Soldering : 350° C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	72.0		180.0	mcd	
Viewing Angle	2 0 1/2		130		deg	
Peak Wavelength	λp		591		nm	
Dominant Wavelength	λd	585.5		594.5	nm	I _F =20mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		15		nm	
Forward Voltage	VF	1.7	2.0	2.4	V	
Reverse Current	Ir			10	μA	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

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Bin Range Of Dom. Wavelength

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Group	Bin	Min	Max	Unit	Condition
	D3	585.5	588.5	nm	I _F =20mA
А	D4	588.5	591.5		
	D5	591.5	594.5		

Bin Range Of Luminous Intensity

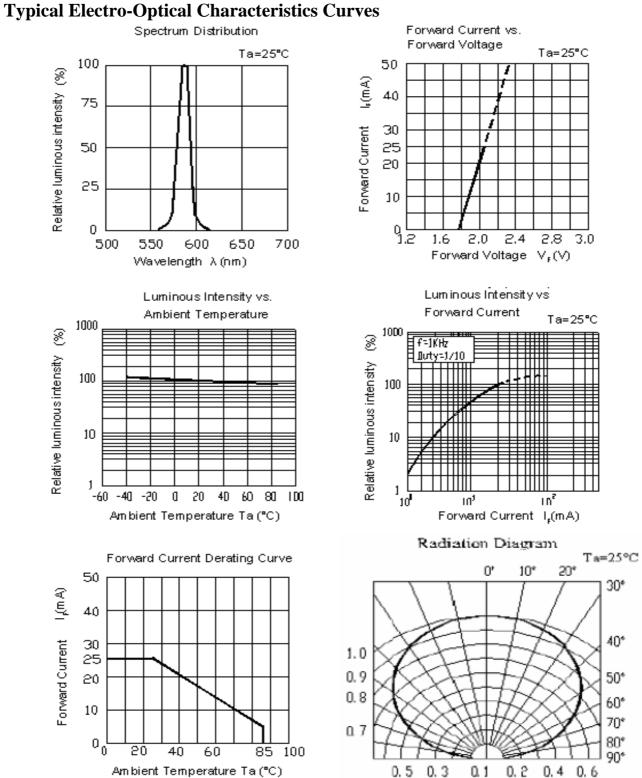
Bin	Min	Max	Unit	Condition	
Q1	72.0	90.0			
Q2	90.0	112	mcd	I _F =20mA	
R1	112	140			
R2	140	180			

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

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Label explanation

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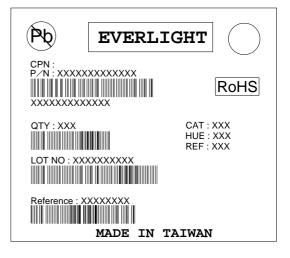
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CAT: Luminous Intensity Rank

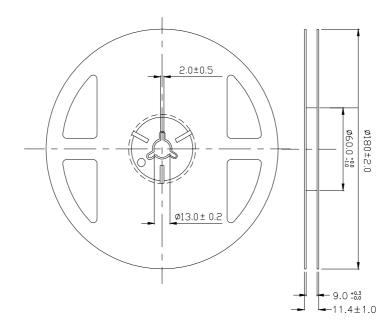
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HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



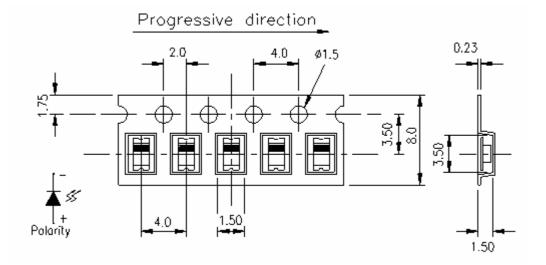
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm , Unit = mm

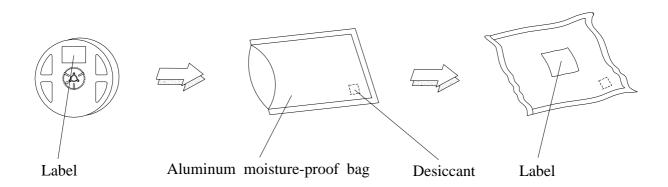
Moisture Resistant Packaging

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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

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LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min \int 10 sec L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 m A$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

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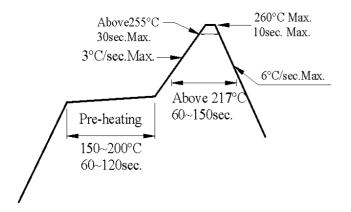
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

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- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5℃ for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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4.Soldering Iron

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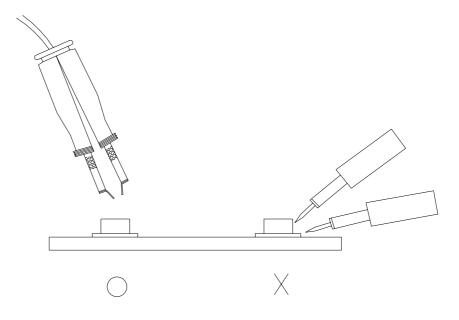
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Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. Device No: DSE-0003102 http://www.everlight.com Prepared date: 20-Jan -2010 Rev. 1 Page: 10 of 10 Prepared by: Wang Jian